

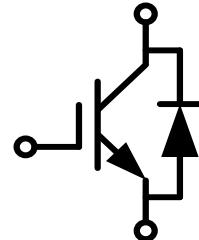
IGBT Discrete with Anti-Parallel Diode

Features

- 650V grooved gate/field termination process
- Low switching loss
- Positive temperature coefficient

Applications

- Charging pile
- OBC
- UPS
- Inverter



$V_{CES} = 650V$, $I_{C\text{ nom}} = 75A$ / $I_{CRM} = 150A$

Ordering Information

Part Number	Package
SKIF50N65-T7	TO-247

IGBT

Maximum Ratings

Parameter	Conditions	Symbol	Value	Unit
Collector-Emitter voltage	$T_{vj}=25^\circ C$	V_{CES}	650	V
Continuous DC collector current	$T_C=100^\circ C$, $T_{vj\text{ max}}=175^\circ C$	$I_{C\text{ nom}}$	50	A
Repetitive peak collector current	$t_p=1\text{ ms}$	I_{CRM}	100	A
Gate charge	$V_{GE}=-15V \dots +15V$	Q_G	0.50	μC
Total power dissipation	$T_C = 25^\circ C$, $T_{vj\text{ max}} = 175^\circ C$	P_{tot}	275	W
Gate emitter voltage		V_{GE}	± 20	V

Characteristic Values

Parameter	Conditions	Symbol	Value			Unit
			Min.	Typ.	Max.	
Collector-Emitter saturation voltage	V _{GE} =15V, I _C =50A V _{GE} =15V, I _C =50A V _{GE} =15V, I _C =50A	T _{vj} =25°C T _{vj} =125°C T _{vj} =150°C	V _{CEsat}	1.58 1.87 1.95	2.10	V
Gate-Emitter threshold voltage	I _C =0.5mA, V _{GE} = V _{CE}	T _{vj} =25°C	V _{GE(th)}	4.2	5.0	5.8
Transconductance	V _{CE} =20V, I _C =50A	G _{fs}		77		S
Input capacitance	f=1 MHz, V _{CE} =25 V, V _{GE} =0 V	T _{vj} =25°C	C _{ies}	5.46		nF
Reverse transfer capacitance			C _{res}	0.1		
Collector-emitter cut-off current	V _{CE} =650V, V _{GE} = 0 V	T _{vj} =25°C	I _{CES}		1	mA
Gate-emitter leakage current	V _{CE} =0 V, V _{GE} = 20 V	T _{vj} =25°C	I _{GES}		200	nA
Turn-on delay time	I _C =50A, V _{CE} =400V V _{GE} =±15V, R _G =8Ω (inductive load)	T _{vj} =25°C T _{vj} =125°C T _{vj} =150°C	t _{d on}	33 21 19		ns
Rise time	I _C =50A, V _{CE} =400V V _{GE} =±15V, R _G =8Ω (inductive load)	T _{vj} =25°C T _{vj} =125°C T _{vj} =150°C	t _r	75 67 65		
Turn-off delay time	I _C =50A, V _{CE} =400V V _{GE} =±15V, R _G =8Ω (inductive load)	T _{vj} =25°C T _{vj} =125°C T _{vj} =150°C	t _{d off}	21 32 38		
Fall time	I _C =50A, V _{CE} =400V V _{GE} =±15V, R _G =8Ω (inductive load)	T _{vj} =25°C T _{vj} =125°C T _{vj} =150°C	t _f	41 62 62		
Turn-on energy loss per pulse	I _C =50A, V _{CE} =400V V _{GE} =±15V, R _G =8Ω (inductive load)	T _{vj} =25°C T _{vj} =125°C T _{vj} =150°C	E _{on}	2.37 2.88 3.10		mJ
Turn-off energy loss per pulse	I _C =50A, V _{CE} =400V V _{GE} =±15V, R _G =8Ω (inductive load)	T _{vj} =25°C T _{vj} =125°C T _{vj} =150°C	E _{off}	0.60 0.73 0.76		
IGBT thermal resistance, junction		R _{thJC}		0.38		K/W
Temperature under switching conditions		T _{vj op}	-40		175	°C

Diode

Maximum Ratings

Parameter	Conditions	Symbol	Value		Unit
Repetitive peak reverse voltage	T _{vj} =25°C	V _{RRM}	650		V
Continuous DC forward current	T _C =100°C, T _{vj max} =175°C	I _F	50		A
Repetitive peak forward current	t _p =1ms	I _{FRM}	100		A

Characteristic Values

Parameter	Conditions	Symbol	Value			Unit
			Min.	Typ.	Max.	
Forward voltage	I _F =50A, V _{GE} =0V	V _F	T _{vj} =25°C T _{vj} =125°C T _{vj} =150°C	1.63 1.42 1.37	2.1	V
	I _F =50A, V _{GE} =0V					
	I _F =50A, V _{GE} =0V					
Peak reverse recovery current	I _F =50A,	I _{RM}	T _{vj} =25°C T _{vj} =125°C T _{vj} =150°C	21 29 32		A
	-dI _F /dt=411A/μs(T _{vj} =150°C)					
	V _R =400V, V _{GE} =-15V					
Reverse Recovered charge	I _F =50A,	Q _{rr}	T _{vj} =25°C T _{vj} =125°C T _{vj} =150°C	1.48 3.26 3.95		μC
	-dI _F /dt=411A/μs(T _{vj} =150°C)					
	V _R =400V, V _{GE} =-15V					
Reverse Recovery Time	I _F =50A,	t _{rr}	T _{vj} =25°C T _{vj} =125°C T _{vj} =150°C	133 199 218		ns
	-dI _F /dt=411A/μs(T _{vj} =150°C)					
	V _R =400V, V _{GE} =-15V					
Reverse recovered energy	I _F =50A,	E _{rec}	T _{vj} =25°C T _{vj} =125°C T _{vj} =150°C	0.34 0.66 0.78		mJ
	-dI _F /dt=411A/μs(T _{vj} =150°C)					
	V _R =400V, V _{GE} =-15V					
Diode thermal resistance junction		R _{thJC}		0.45		K/W
Temperature under switching conditions		T _{vj op}	-40		175	°C

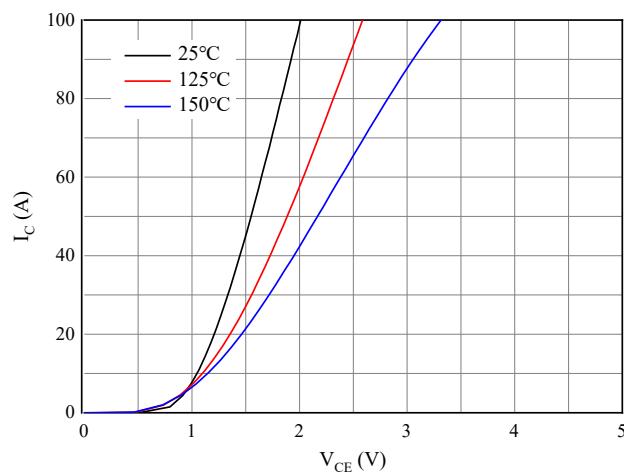


Figure 1. Typical output characteristics ($V_{GE}=15V$)

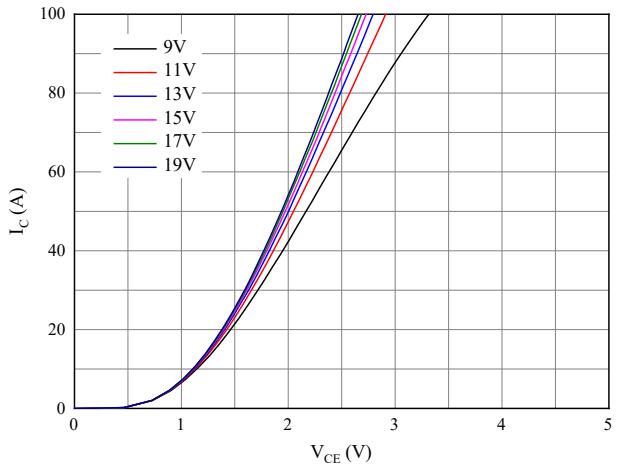


Figure 2. Typical output characteristics ($T_{vj}=150^{\circ}C$)

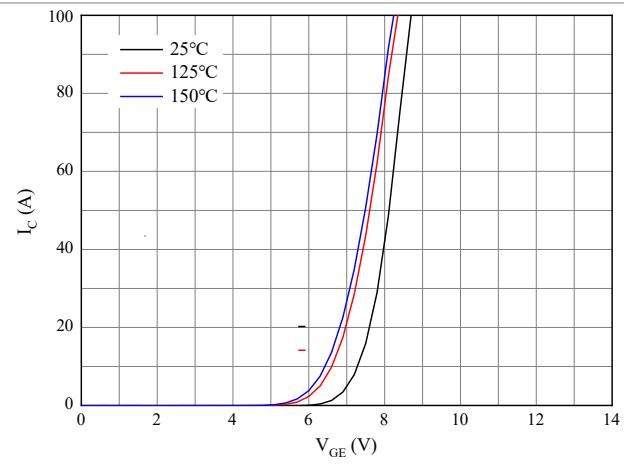


Figure 3. Typical transfer characteristic($V_{CE}=20V$)

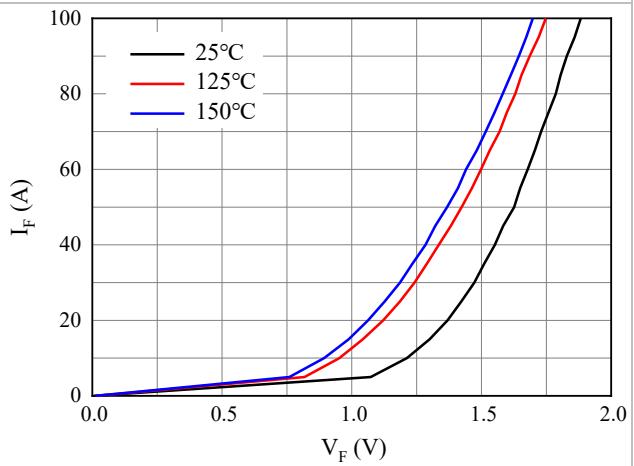


Figure 4. Forward characteristic of Diode

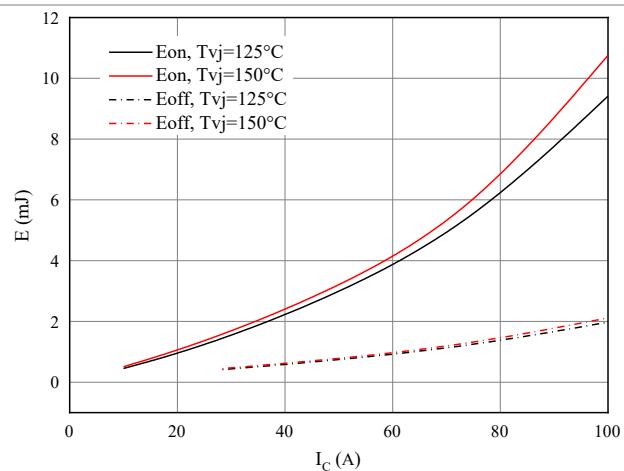


Figure 5. Switching losses of IGBT

$V_{GE}=\pm 15V$, $R_{Gon}=8\Omega$, $R_{goff}=8\Omega$, $V_{CE}=400V$

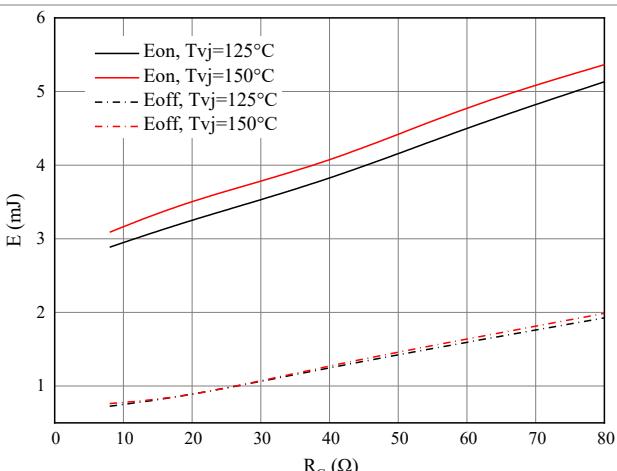


Figure 6. Switching losses of IGBT

$V_{GE}=\pm 15V$, $I_C=50A$, $V_{CE}=400V$

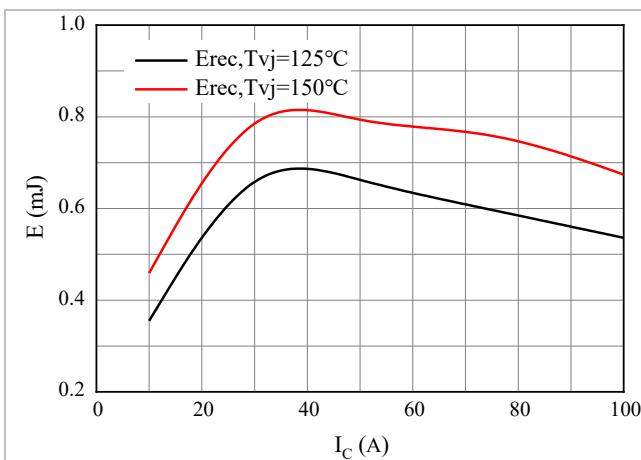


Figure 7. Switching losses of Diode
 $R_{\text{gon}}=8\Omega$, $V_{\text{CE}}=400\text{V}$

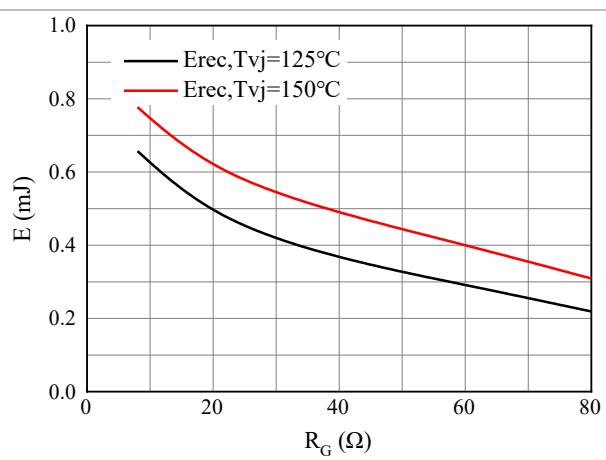


Figure 8. Switching losses of Diode
 $I_F=50\text{A}$, $V_{\text{CE}}=400\text{V}$

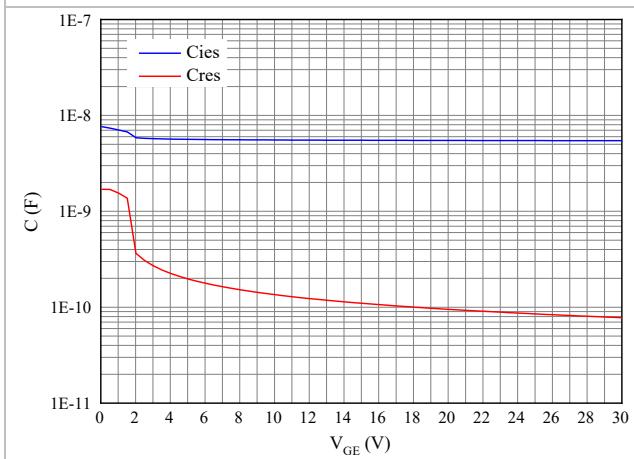
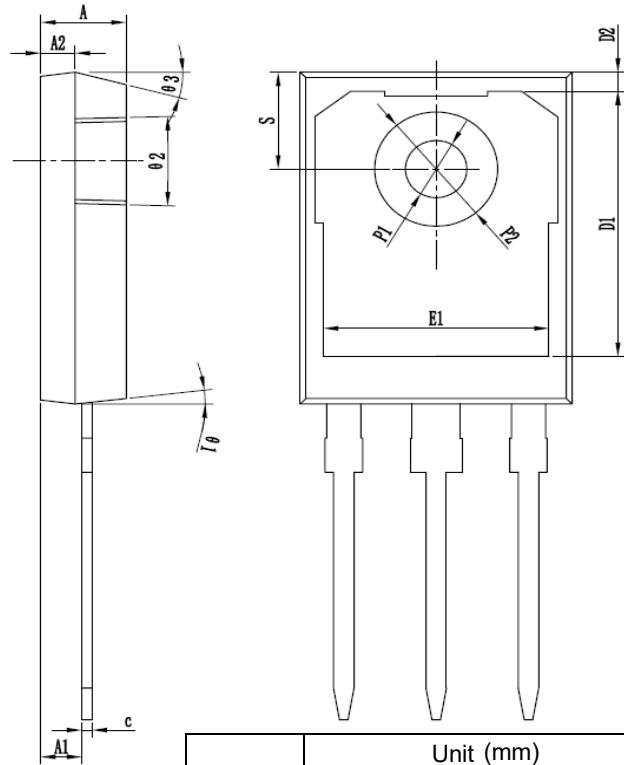
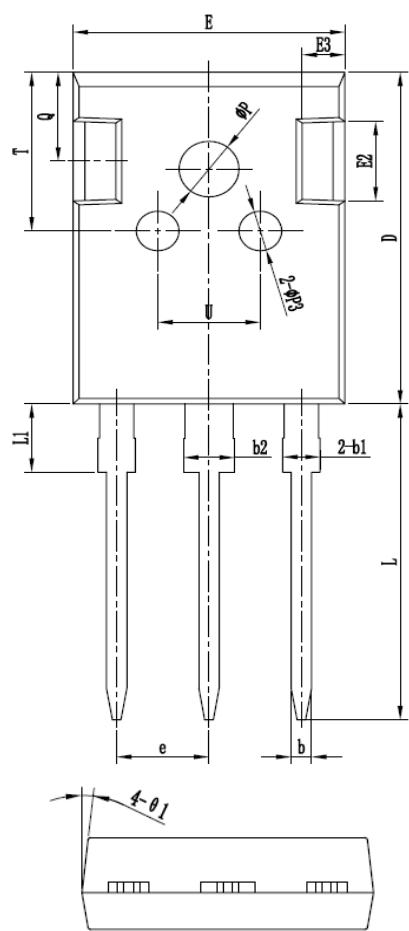


Figure 9. Capacitance characteristic


TO-247

	Unit (mm)		
	MIN	NOM	MAX
A	4.90	5.00	5.10
A1	2.31	2.41	2.51
A2	1.90	2.00	2.10
b	1.15	1.20	1.25
b1	1.95	2.10	2.25
b2	2.95	3.10	3.25
c	0.55	0.60	0.65
D	20.90	21.00	21.10
D1	16.35	16.55	16.75
D2	1.05	1.20	1.35
E	15.70	15.80	15.90
E1	13.10	13.25	13.40
E2	4.90	5.00	5.10
E3	2.40	2.50	2.60
e	5.40	5.44	5.48
L	19.80	19.92	20.10
L1	-	-	4.30
ΦP	3.70	3.80	3.90
ΦP1	3.50	3.60	3.70
ΦP2	3.70	3.70	3.90
ΦP3	7.00	7.20	7.40
Q	5.60	5.80	6.00
S	6.05	6.15	6.25
J	9.80	10.00	10.20
U	6.00	6.20	6.40
θ_1	5°	7°	9°
θ_2	1°	3°	5°
θ_3	13°	15°	17°